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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Ponnekanti et al. §
§
§
Serial No.: Unknown § Group Art Unit: Unknown
§
Filed: Herewith § Examiner: Unknown
§
§
For: A Process And An Integrated Tool §
For Low K Dielectric Deposition Including §
A Pecvd Capping Module §



CERTIFICATE OF MAILING
37 C.F.R. 1.8
<p>I hereby certify that this correspondence is being deposited on <u>2/10/2000</u>, 2000, with the U. S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.</p> <p><u>Reed M. Mulcahy</u></p> <p>Date Signature</p>

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

INFORMATION DISCLOSURE STATEMENT

The applicants, and the attorney who signs below on the basis of the information supplied by the inventor and the information in his file, submit herewith patents, publications, or other information of which they are aware, which may be material to the examination of this application and in respect of which there may be a duty to disclose in accordance with 37 C.F.R.

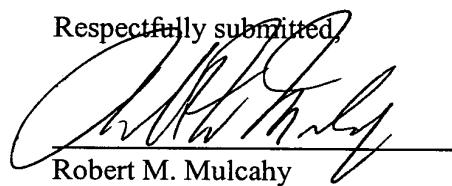
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In accordance with 37 C.F.R. § 1.97, this Information Disclosure Statement is not to be construed as a representation that a search has been made or that no other possibly material information as defined in 37 C.F.R. § 1.56(a) exists.

PATENT
Atty. Dkt. AMAT/3422/MD/PLUG/DV

The patents and/or publications submitted herewith are set forth on the attached Form PTO-1449.

Respectfully submitted,



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